

APPROVAL SHEET

FREE ANTENNA

RGFRA Series / Pb free

2.4 GHz ISM Band Working Frequency

P/N: RGFRA1903041A5T

*Contents in this sheet are subject to change without prior notice.■

FEATURES

1. Surface Mounted Devices with a small dimension of $19 \times 3 \times 3.8 \text{ mm}^3$.
2. Able to be placed above/on ground plane. No external keep-out zone (empty space) required, which relatively save more space on PC board.
3. Allow placing other components besides antenna or on the backside of PCB right underneath antenna.
4. No sensitive to environmental includes hand effects. Ideal for Handheld devices application.

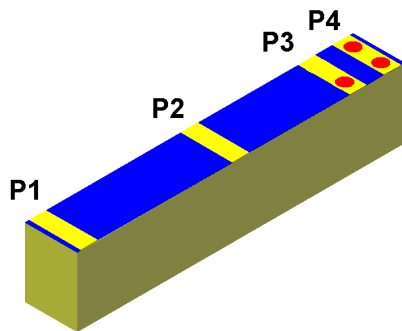
APPLICATIONS

1. Bluetooth, ISM 2.4GHz in samrt phone, PDA and other handheld devices.
2. ISM band 2.4GHz applications

DESCRIPTION

Walsin Technology Corporation develops a new antenna specified for 2.4 GHz ISM Band application, as shown in below "CONSTRUCTION". It's application typically located on this unlicensed frequency band which range covers from 2.4GHz to 2.4835GHz. To fulfill the friendly usage for antenna, this antenna has been designed to no empty space required and no sensitive to environmental through Walsin's superior product design via 3D EM Simulation Skill.

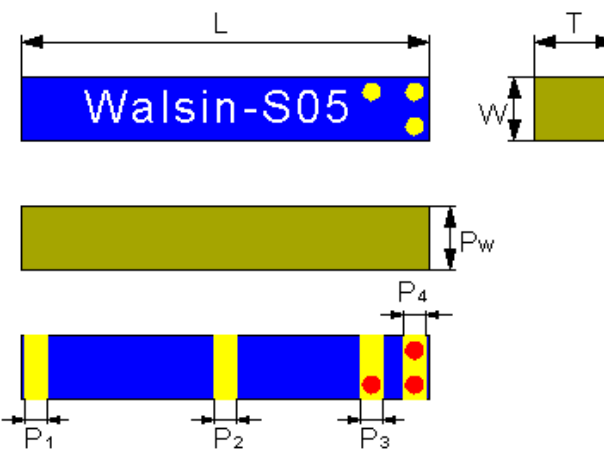
CONSTRUCTION



PIN	Definition
P1	Soldering
P2	Soldering
P3	Feed
P4	Gronud

Fig 1. Outline of Free Antenna – RGFR1903041A5T

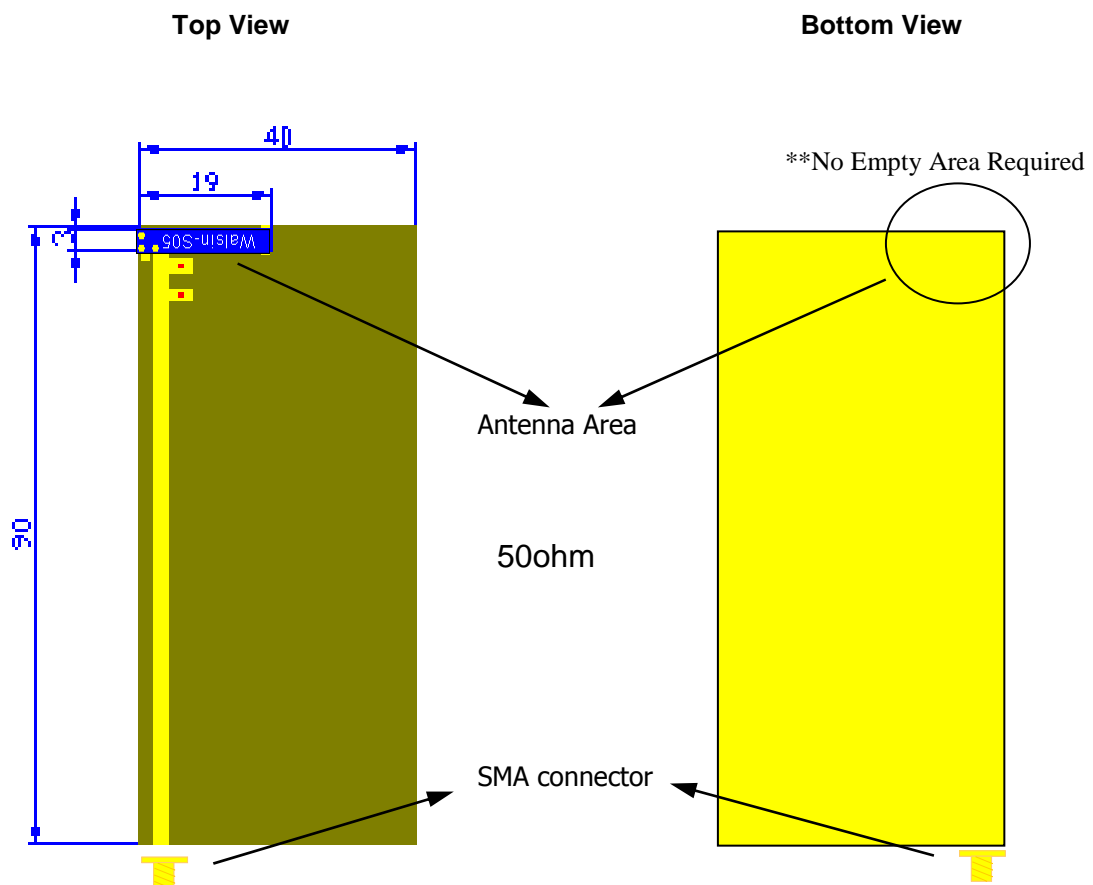
DIMENSIONS

Figure	Dimension		Port definition
	L	$19.0 \pm 0.15 \text{ mm}$	-
	W	$3.0 \pm 0.15 \text{ mm}$	-
	T	$3.8 \pm 0.20 \text{ mm}$	-
	P_w	$3.0 \pm 0.10 \text{ mm}$	Pad width
	P_1	$1.0 \pm 0.10 \text{ mm}$	Soldering terminal
	P_2	$1.0 \pm 0.10 \text{ mm}$	Soldering terminal
	P_3	$1.0 \pm 0.10 \text{ mm}$	Feed terminal
	P_4	$1.0 \pm 0.10 \text{ mm}$	Ground terminal

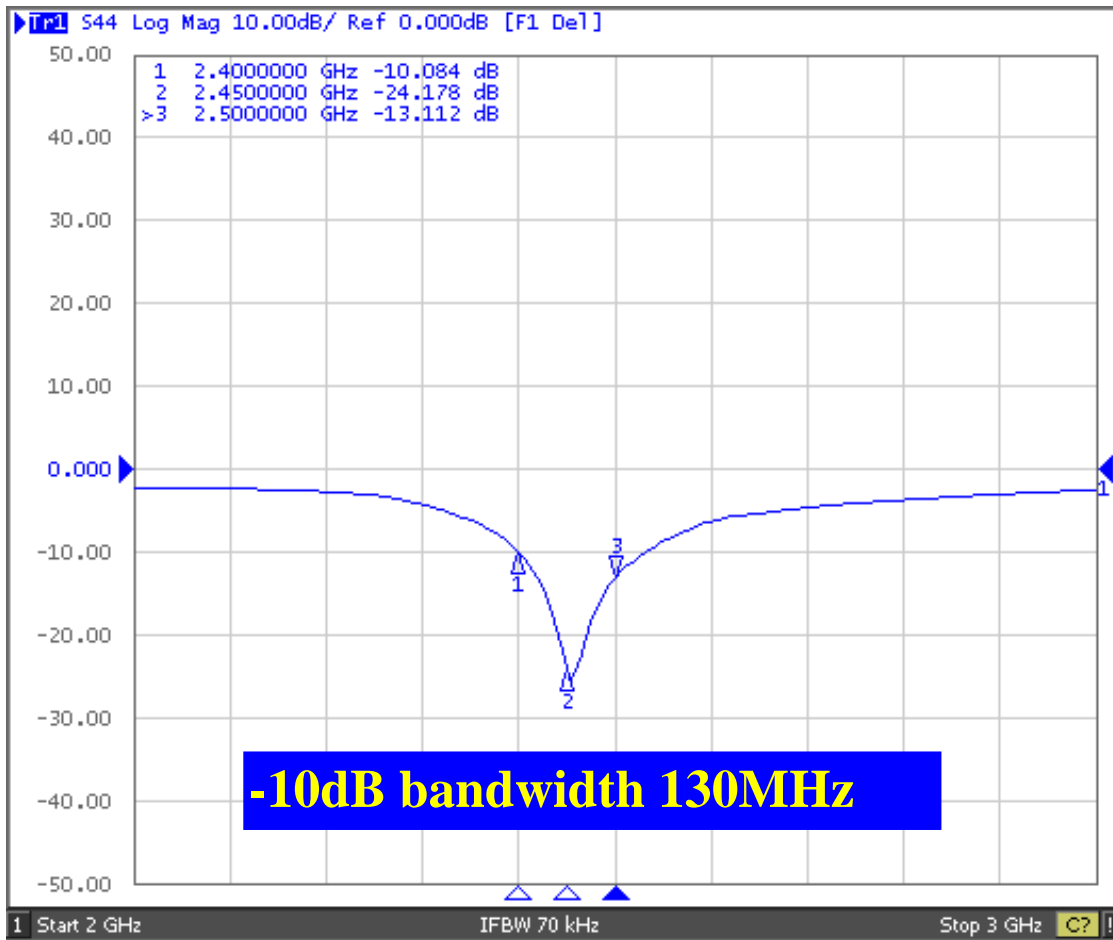
ELECTRICAL CHARACTERISTICS

RGFRA1903041A5T	Specification
Working Frequency Range	2.4 GHz ~ 2.5GHz
Gain	2 dBi (Typical)
VSWR	2 max.
Polarization	Linear
Azimuth Bandwidth	Omni-directional
Impedance	50Ω
Rated Power (max.)	1 W
Operation Temperature	-40°C ~ +85°C

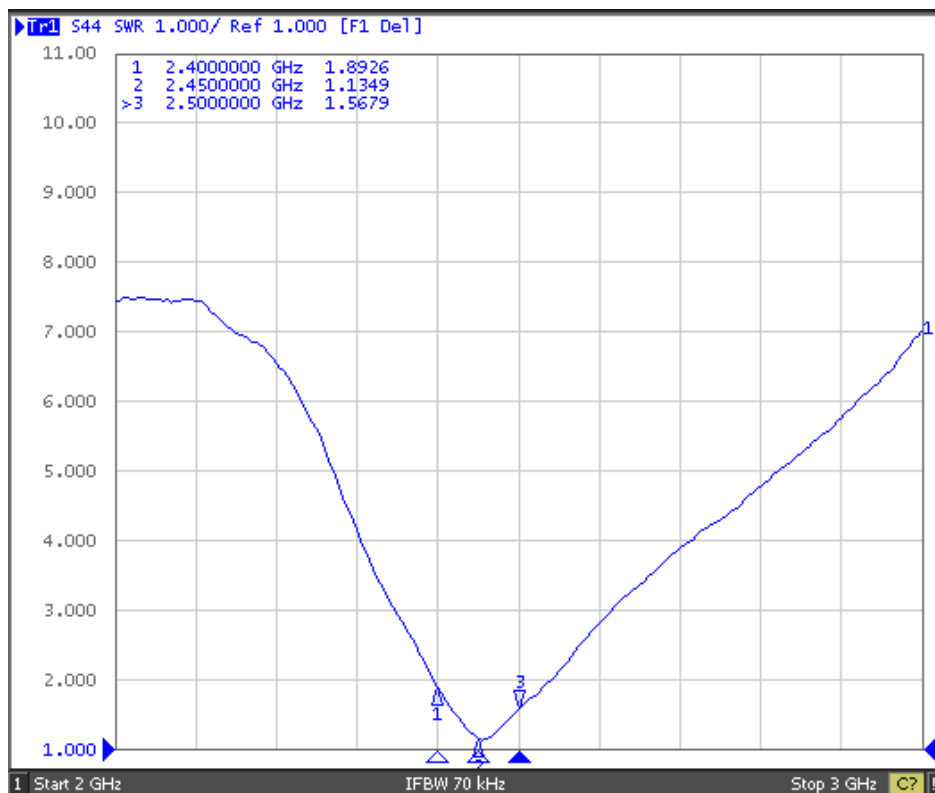
Remark: The specification is defined based on the test board dimension as in below

Antenna on Test Board

Antenna S11 on Test Board



VSWR:

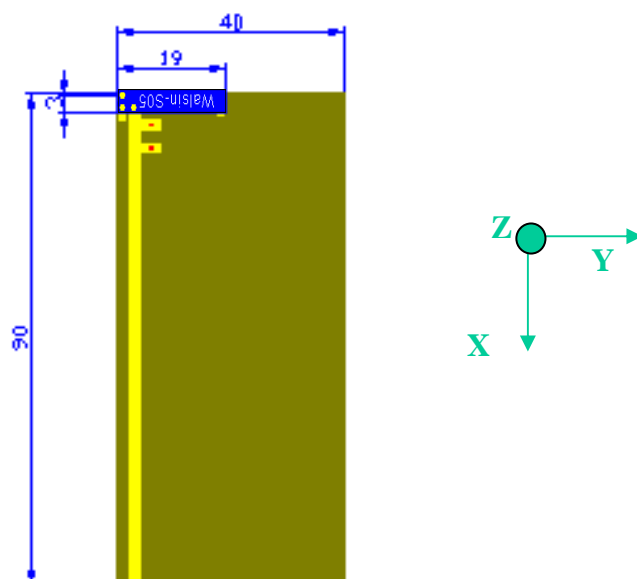


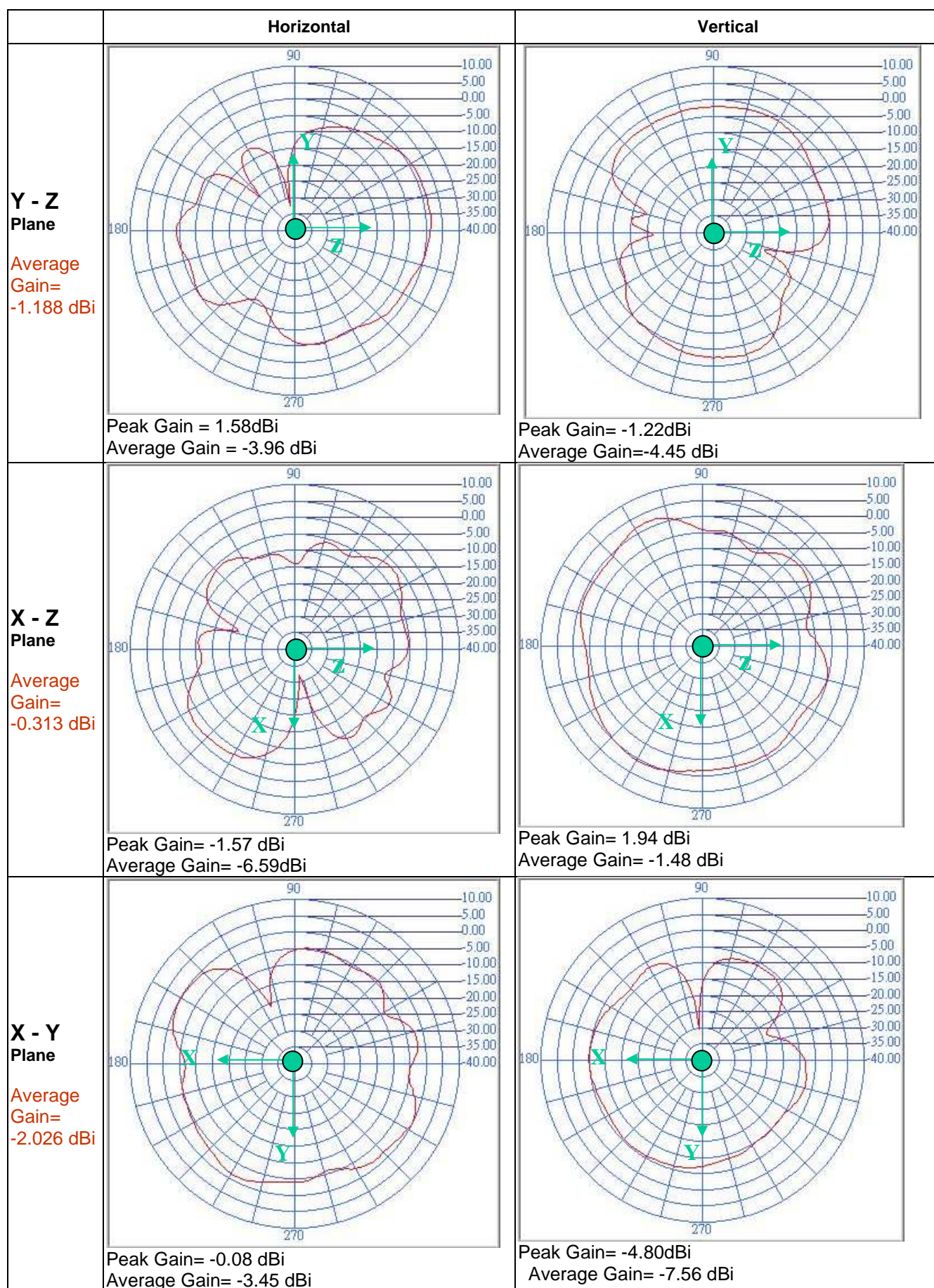
SOLDER LAND PATTERN DESIGN

Figure	Symbol	Dimension
Unit: mm		
<p>The diagram shows a vertical layout of a solder land pattern. It includes a green rectangle at the top (Ground), a red rectangle below it (Feed), and two cyan rectangles further down (Soldering pads). A dashed pink rectangle outlines the entire antenna structure. Dimensions are indicated with arrows: 3.6 mm for the width of the top section, 1 mm for the spacing between the top two sections, 5.8 mm for the height of the feed section, 1.9 mm for the height of the first soldering pad, 7.8 mm for the height of the second soldering pad, and 3 mm for the width of the bottom section. A total height dimension of 19 mm is also shown for the lower part of the structure.</p>		
	Ground, connect to ground Feed, connected to 50ohm transmission line Soldering pads Antenna outline	

RADIATION PATTERN

Radiation Pattern and Gain were dependent on measurement board design. The specification of RGFR1903041A5T antenna was measured based on the test board size and the antenna installation position as shown in the below:





RELIABILITY TEST

Test item	Test condition / Test method	Specification
Solderability JIS C 0050-4.6 JESD22-B102D	*Solder bath temperature : $235 \pm 5^{\circ}\text{C}$ *Immersion time : 2 ± 0.5 sec *Solder : Sn3Ag0.5Cu for lead-free	At least 95% of a surface of each terminal electrode must be covered by fresh solder.
Leaching (Resistance to dissolution of metallization) IEC 60068-2-58	*Solder bath temperature : $260 \pm 5^{\circ}\text{C}$ *Leaching immersion time : 30 ± 0.5 sec *Solder : SN63A	Loss of metallization on the edges of each electrode shall not exceed 25%.
Resistance to soldering heat JIS C 0050-5.4	*Preheating temperature : $120 \sim 150^{\circ}\text{C}$, 1 minute. *Solder temperature : $270 \pm 5^{\circ}\text{C}$ *Immersion time : 10 ± 1 sec *Solder : Sn3Ag0.5Cu for lead-free Measurement to be made after keeping at room temperature for 24 ± 2 hrs	No mechanical damage. Samples shall satisfy electrical specification after test. Loss of metallization on the edges of each electrode shall not exceed 25%.
Drop Test JIS C 0044	*Height : 75 cm *Test Surface : Rigid surface of concrete or steel. *Times : 6 surfaces for each units ; 2 times for each side.	No mechanical damage. Samples shall satisfy electrical specification after test.
Adhesive Strength of Termination JIS C 0051- 7.4.3	*Pressurizing force : $5\text{N}(\leq 0603)$; $10\text{N}(> 0603)$ *Test time : 10 ± 1 sec	No remarkable damage or removal of the termination.
Bending test JIS C 0051- 7.4.1	The middle part of substrate shall be pressurized by means of the pressurizing rod at a rate of about 1 mm/s per second until the deflection becomes 1mm/s and then pressure shall be maintained for 5 ± 1 sec. Measurement to be made after keeping at room temperature for 24 ± 2 hours	No mechanical damage. Samples shall satisfy electrical specification after test.

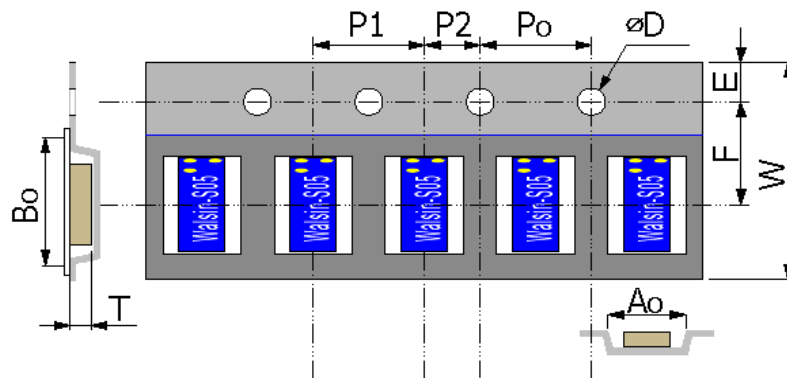
Temperature cycle JIS C 0025	1. 30±3 minutes at -40°C±3°C, 2. 10~15 minutes at room temperature, 3. 30±3 minutes at +85°C±3°C, 4. 10~15 minutes at room temperature, Total 100 continuous cycles Measurement to be made after keeping at room temperature for 24±2 hrs	No mechanical damage. Samples shall satisfy electrical specification after test.
Vibration JIS C 0040	*Frequency : 10Hz~55Hz~10Hz(1min) *Total amplitude : 1.5mm *Test times : 6hrs.(Two hrs each in three mutually perpendicular directions)	No mechanical damage. Samples shall satisfy electrical specification after test.
High temperature JIS C 0021	*Temperature : 85°C±2°C *Test duration : 1000+24/-0 hours Measurement to be made after keeping at room temperature for 24±2 hrs	No mechanical damage. Samples shall satisfy electrical specification after test.
Humidity (steady conditions) JIS C 0022	*Humidity : 90% to 95% R.H. *Temperature : 40±2°C *Time : 1000+24/-0 hrs. Measurement to be made after keeping at room temperature for 24±2 hrs ※ 500hrs measuring the first data then 1000hrs data	No mechanical damage. Samples shall satisfy electrical specification after test.
Low temperature JIS C 0020	*Temperature : -40°C±2°C *Test duration : 1000+24/-0 hours Measurement to be made after keeping at room temperature for 24±2 hrs	No mechanical damage. Samples shall satisfy electrical specification after test.

ORDERING CODE

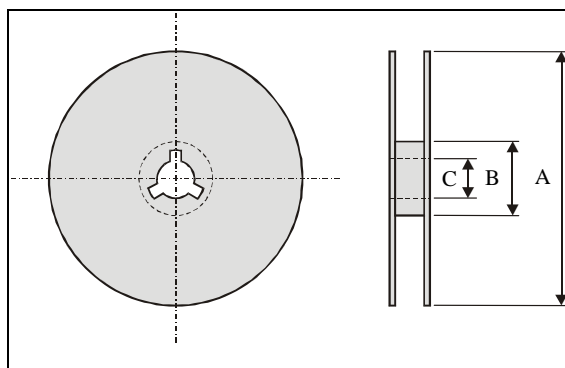
RG	FRA	190304	1	A	1	T
Walsin RG: RF /Pb free device	Product code FRA : Antenna	Dimension code Per 2 digits of Length, Width, Thickness : e.g. : 190304= Length 19.0, Width 3.0, Thickness 3.8	Unit of dimension 0 : 0.1 mm 1 : 1.0 mm	Application A : 2.4GHZ ISM Band	Specification Design Code	Packing T : Reeled

PACKAGING

Plastic Tape specifications (unit :mm)



Index	Ao	B0	ΦD	T	W
Dimension (mm)	3.25 ± 0.1	19.35 ± 0.1	1.55 ± 0.05	4.05 ± 0.1	32 ± 0.3
Index	E	F	Po	P1	P2
Dimension (mm)	1.75 ± 0.1	14.2 ± 0.1	4.0 ± 0.1	12.0 ± 0.1	2.0 ± 0.1

Reel dimensions

Index	A	B	C
Dimension (mm)	Φ330±1	Φ99 ±1	Φ17.4 ± 0.5

Typing Quantity: 1000 pieces per 13" reel

CAUTION OF HANDLING

Limitation of Applications

Please contact us before using our products for the applications listed below which require especially high reliability for the prevention of defects, which might directly cause damage to the third party's life, body or property.

- (1) Aircraft equipment
- (2) Aerospace equipment
- (3) Undersea equipment
- (4) Medical equipment
- (5) Disaster prevention / crime prevention equipment
- (6) Traffic signal equipment
- (7) Transportation equipment (vehicles, trains, ships, etc.)
- (8) Applications of similar complexity and /or reliability requirements to the applications listed in the above.

Storage condition

- (1) Products should be used in 6 months from the day of WALSIN outgoing inspection, which can be confirmed.
- (2) Storage environment condition.
 - Products should be storage in the warehouse on the following conditions.
 - Temperature : -10 to +40°C
 - Humidity : 30 to 70% relative humidity
 - Don't keep products in corrosive gases such as sulfur. Chlorine gas or acid or it may cause oxidization of electrode, resulting in poor solderability.
 - Products should be storage on the palette for the prevention of the influence from humidity, dust and son on.
 - Products should be storage in the warehouse without heat shock, vibration, direct sunlight and so on.
 - Products should be storage under the airtight packaged condition.